

November 1994

# 54F/74F04 Hex Inverter

# **General Description**

### **Features**

This device contains six independent gates, each of which performs the logic INVERT function.

■ Guaranteed 4000V minimum ESD protection

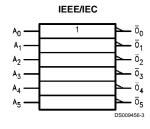
# Ordering Code: See Section 0

Commercial	Military	Package	Package Description
		Number	
74F04PC		N14A	14-Lead (0.300" Wide) Molded Dual-In-Line
	54F04DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line
74F04SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC
74F04SJ (Note 1)		M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ
	54F04FM (Note 2)	W14B	14-Lead Cerpack
	54F04LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

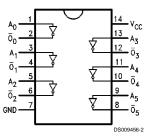
Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

# **Logic Symbol**

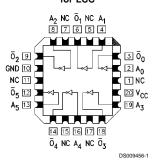


# **Connection Diagrams**

Pin Assignment for DIP, SOIC and Flatpak



Pin Assignment for LCC



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# Unit Loading/Fan Out See Section 0 for U.L. definitions

		54F/74F				
Pin Names	Description	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>			
		HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>			
A <sub>n</sub>	Inputs	1.0/1.0	20 μA/-0.6 mA			
$\overline{O}_n$	Outputs	50/33.3	–1 mA/20 mA			

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### **Absolute Maximum Ratings** (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature -65°C to +150°C

Ambient Temperature under Bias -55°C to +125°C

Junction Temperature under Bias -55°C to +175°C

Plastic -55°C to +150°C

 $V_{\rm CC}$  Pin Potential to

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

Standard Output -0.5V to  $V_{CC}$ TRI-STATE® Output -0.5V to +5.5V Current Applied to Output

in LOW State (Max) twice the rated  $I_{OL}$  (mA) ESD Last Passing Voltage (Min) 4000V

# Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage

Military +4.5V to +5.5V Commercial +4.5V to +5.5V

**Note 3:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

### **DC Electrical Characteristics**

Symbol	Parameter		54F/74F			Units	V <sub>cc</sub>	Conditions	
			Min	Тур	Max				
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.2	V	Min	I <sub>IN</sub> = -18 mA	
V <sub>OH</sub>	Output HIGH	54F 10% V <sub>CC</sub>	2.5					I <sub>OH</sub> = -1 mA	
	Voltage	74F 10% V <sub>CC</sub>	2.5			V	Min	I <sub>OH</sub> = -1 mA	
		74F 5% $V_{\rm CC}$	2.7					I <sub>OH</sub> = -1 mA	
V <sub>OL</sub>	Output LOW	54F 10% V <sub>CC</sub>			0.5	V	Min	I <sub>OL</sub> = 20 mA	
	Voltage	74F 10% V <sub>CC</sub>			0.5			I <sub>OL</sub> = 20 mA	
I <sub>IH</sub>	Input HIGH	54F			20.0	μΑ	Max	V <sub>IN</sub> = 2.7V	
	Current	74F			5.0				
I <sub>BVI</sub>	Input HIGH Current	54F			100	μΑ	Max	V <sub>IN</sub> = 7.0V	
	Breakdown Test	74F			7.0				
I <sub>CEX</sub>	Output HIGH	54F			250	μΑ	Max	V <sub>OUT</sub> = V <sub>CC</sub>	
	Leakage Current	74F			50				
V <sub>ID</sub>	Input Leakage	74F	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA	
	Test							All other pins grounded	
I <sub>OD</sub>	Output Leakage	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV	
	Circuit Current							All other pins grounded	
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V	
I <sub>os</sub>	Output Short-Circuit Current		-60		-150	mA	Max	V <sub>OUT</sub> = 0V	
I <sub>CCH</sub>	Power Supply Current			2.8	4.2	mA	Max	V <sub>O</sub> = HIGH	
I <sub>CCL</sub>	Power Supply Current			10.2	15.3	mA	Max	V <sub>O</sub> = LOW	

### **AC Electrical Characteristics**

See Section 0 for Waveforms and Load Configurations

	Parameter	74F T <sub>A</sub> = +25°C V <sub>CC</sub> = +5.0V C <sub>L</sub> = 50 pF			54F T <sub>A</sub> , V <sub>CC</sub> = Mil C <sub>L</sub> = 50 pF		74F T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF		Units	Fig. No.
Symbol										
		Min	Тур	Max	Min	Max	Min	Max	1	
t <sub>PLH</sub>	Propagation Delay	2.4	3.7	5.0	2.0	7.0	2.4	6.0	ns	**-**
t <sub>PHL</sub>	$A_n$ to $\overline{O}_n$	1.5	3.2	4.3	1.5	6.5	1.5	5.3		

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DSXXX

DSXXX

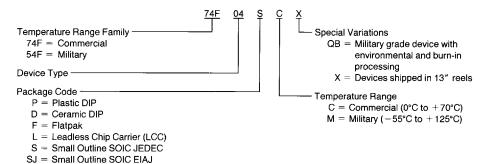
Book Extrac End

**Proof** 

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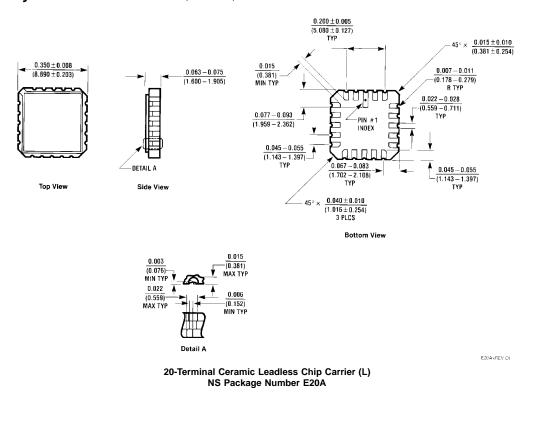


The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



DS009456-4

# Physical Dimensions inches (millimeters) unless otherwise noted



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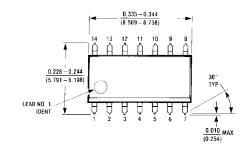
#### 0.785 (19.939) (19.939) MAX 14 13 12 11 10 9 8 0.025 (0.635) RAD 0.220-0.310 (5.588-7.874) 1 2 3 4 5 6 7 0.005 (0.127) MIN 0.290-0.320 0.200 GLASS SEALANT (5.080) MAX 0.020-0.060 (7.366-8.128) 0.060 ±0.005 (1.524 ±0.127) 0.180 (4.572) MA (0.508-1.524)∮95° ±5° 86°94° TYP \_10° MAX 0.008-0.012 0.310-0.410 (0.203-0.305) 0.018 ±0.003 0.125--0.200 0.098 (7.874-10.41) (0.457 ±0.076) (3.175-5.080)

(2.489) MAX BOTH ENDS

14-Lead Ceramic Dual-In-Line Package (D)
NS Package Number J14A

0.100 ±0.010

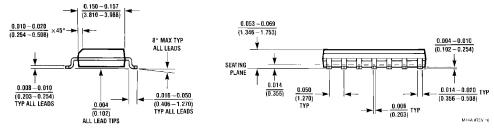
(2.540 ±0.254)



0.150

(3.81) MIN

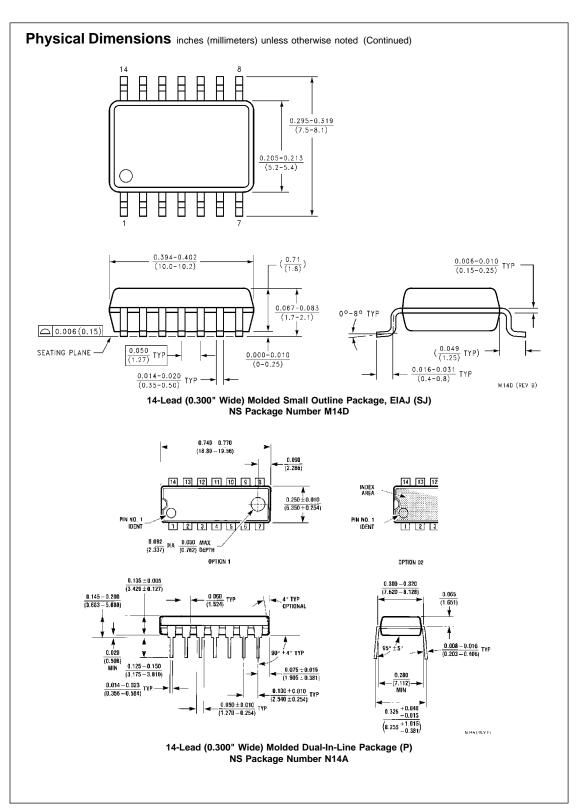
J14A (REV G)



14-Lead (0.150" Wide) Molded Small Outline Package, JEDEC (S) NS Package Number M14A

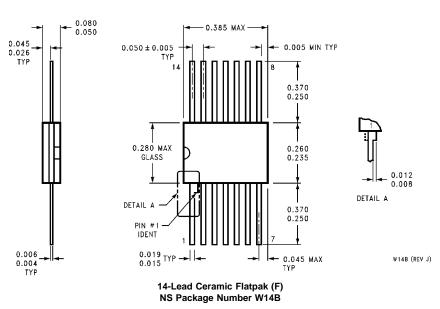
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### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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